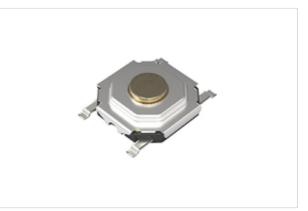


Surface Mount Type TACT Switch^M > SKQG Series > SKQGABE010

5.2mm Square Low-profile Type (Surface Mount) SKQG Series

| <u>Dimensions</u> | <u>Land Dimensions</u> | <u>Circuit Diagram</u> | <u>Packing Specifications</u> |

Soldering Conditions



Part number <u>Series Common Info</u> SKQGABE010

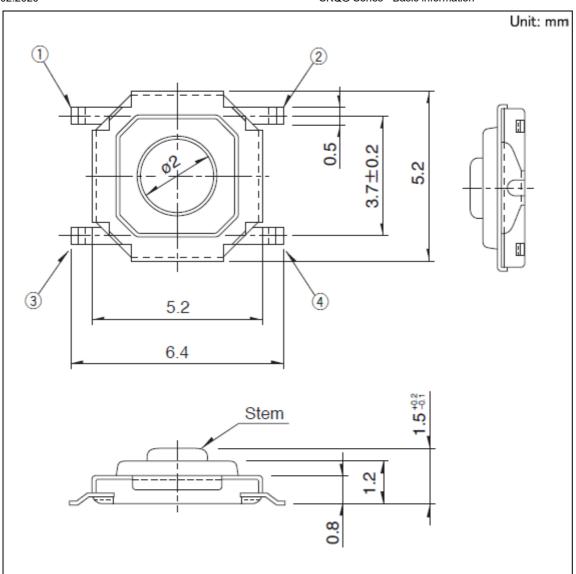


With stem

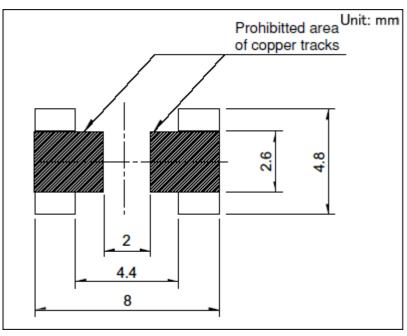
Туре	Surface mount
Operating force	1.57N
Operating direction	Top push
Travel	0.25mm
Operating life (5mA 5V DC)	1,000,000 cycles
Initial contact resistance	$100 \text{m}\Omega$ max.

7.02.2020		SKQG Series - Basic information
Series type		Sharp feeling type
Operating temp range	perature	-40°C to +90°C
Rating (max.)		50mA 12V DC
Rating (min.)		10µA 1V DC
Electrical performance	Insulation resistance	$100 M\Omega$ min. 100V DC for 1min.
	Voltage proof	250V AC for 1 min.
Durability	Vibration	10 to 55 to 10Hz/min., the amplitude is 1.5mm for all the frequencies, in the 3 direction of X, Y and Z for 2 hours respectively
	Cold	$-30 \pm 2^{\circ}$ C for 96h
Environmental	Dry heat	$80 \pm 2^{\circ}$ C for 96h
performance	Damp heat	60±2°C, 90 to 95%RH for 96h
Minimum orde	r unit (pcs.)	Japan 4,000 Export 4,000

Dimensions

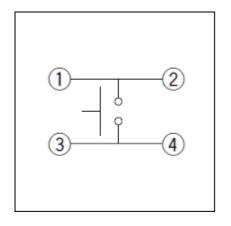


Land Dimensions



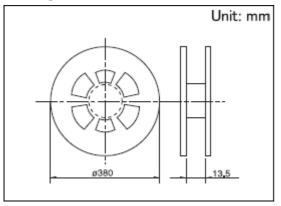
Viewed from mounting face.

Circuit Diagram



Packing Specifications





	1 reel	4,000
Number of	1 case / Japan	40,000
packages (pcs.)	1 case / export packing	40,000
Tape width (mm)		12

Export package measurements (mm) $395 \times 395 \times 205$

Soldering Conditions

Condition for Reflow

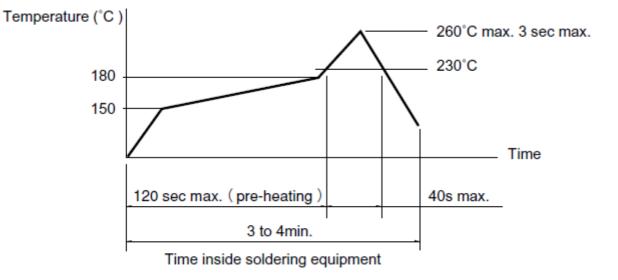
1. Heating method

Double heating method with infrared heater.

2. Temperature measurement

Thermocouple 0.1 to 0.2 Φ CA(K) or CC(T) at solder joints (copper foil surface). A heat resisting tape should be used for fix measurement.

3. Temperature profile



(1) The above temperature shall be measured of the top of switch. There are cases where PC board's temperature greatly differs from that of the switch, depending on the material, size, thickness of PC board's and others. Care, should be taken to prevent the switch's surface temperature from exceeding 260°C.

(2) Soldering conditions differ depending on reflow soldering machines. Prior verification of soldering condition is highly recommended.

Manual Soldering

ItemsConditionSoldering temperature350°C max.Duration of soldering3s max.Capacity of soldering iron60W max.

- 1. Do not washing the TACT Switch^{M}.
- 2. Prevent flux penetration from the top side of the TACT switch[™].
- 3. Switch terminals and a PC board should not be coated with flux prior to soldering.
- 4. The second soldering should be done after the switch returns to normal temperature.

Notes are common to this series/models.

1. This site catalog shows only outline specifications. When using the products, please obtain formal specifications for supply.

- 2. For ϕ 330mm diameter reel requirements, please contact us.
- 3. This products can be used in vehicles.

Although these products are designed to perform over a wide operating temperature range, please ensure that you receive and read the formal delivery specifications before use.

Inquiries about Products

<u>Inquiry</u>

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